

# 74HC257; 74HCT257

Quad 2-input multiplexer; 3-state

Rev. 6 — 26 January 2015

Product data sheet

## 1. General description

The 74HC257; 74HCT257 are high-speed Si-gate CMOS devices and are pin compatible with Low-power Schottky TTL (LSTTL).

The 74HC257 and 74HCT257 have four identical 2-input multiplexers with 3-state outputs, which select 4 bits of data from two sources and are controlled by a common data select input (S).

The data inputs from source 0 (1I0 to 4I0) are selected when input S is LOW and the data inputs from source 1 (1I1 to 4I1) are selected when S is HIGH. Data appears at the outputs (1Y to 4Y) in true (non-inverting) form from the selected inputs.

The 74HC257 and 74HCT257 are the logic implementation of a 4-pole, 2-position switch, where the position of the switch is determined by the logic levels applied to S. The outputs are forced to a high-impedance OFF-state when  $\overline{OE}$  is HIGH.

The logic equations for the outputs are:

$$1\bar{Y} = \overline{OE} \cdot (1I1 \cdot S \cdot 1I0 \cdot \bar{S})$$

$$2\bar{Y} = \overline{OE} \cdot (2I1 \cdot S \cdot 2I0 \cdot \bar{S})$$

$$3\bar{Y} = \overline{OE} \cdot (3I1 \cdot S \cdot 3I0 \cdot \bar{S})$$

$$4\bar{Y} = \overline{OE} \cdot (4I1 \cdot S \cdot 4I0 \cdot \bar{S})$$

Except for their non-inverting (true) outputs the 74HC257; 74HCT257 are identical to the 74HC258.

## 2. Features and benefits

- Non-inverting data path
- 3-state outputs interface directly with system bus
- Complies with JEDEC standard no. 7A
- ESD protection:
  - ◆ HBM JESD22-A114F exceeds 2000 V
  - ◆ MM JESD22-A115-A exceeds 200 V
- Multiple package options
- Specified from  $-40\text{ }^{\circ}\text{C}$  to  $+85\text{ }^{\circ}\text{C}$  and from  $-40\text{ }^{\circ}\text{C}$  to  $+125\text{ }^{\circ}\text{C}$



## 3. Ordering information

Table 1. Ordering information

| Type number | Package           |         |  | Version  |
|-------------|-------------------|---------|--|----------|
|             | Temperature range | Name    | Description  |          |
| 74HC257N    | -40 °C to +125 °C | DIP16   | plastic dual in-line package; 16 leads (300 mil)                       | SOT38-4  |
| 74HCT257N   |                   |         |  |          |
| 74HC257D    | -40 °C to +125 °C | SO16    | plastic small outline package; 16 leads; body width 3.9 mm             | SOT109-1 |
| 74HCT257D   |                   |         |  |          |
| 74HC257DB   | -40 °C to +125 °C | SSOP16  | plastic shrink small outline package; 16 leads; body width 5.3 mm      | SOT338-1 |
| 74HCT257DB  |                   |         |  |          |
| 74HC257PW   | -40 °C to +125 °C | TSSOP16 | plastic thin shrink small outline package; 16 leads; body width 4.4 mm | SOT403-1 |
| 74HCT257PW  |                   |         |  |          |

## 4. Functional diagram

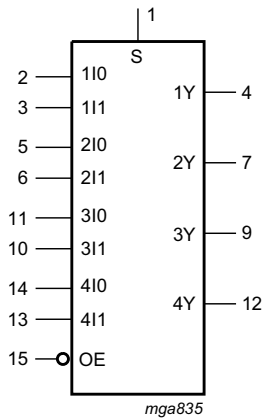


Fig 1. Logic symbol

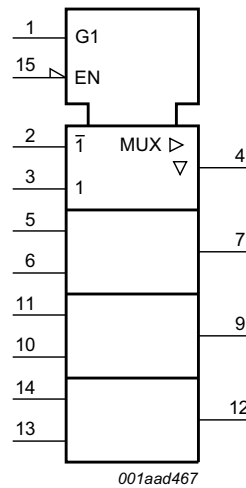


Fig 2. IEC logic symbol

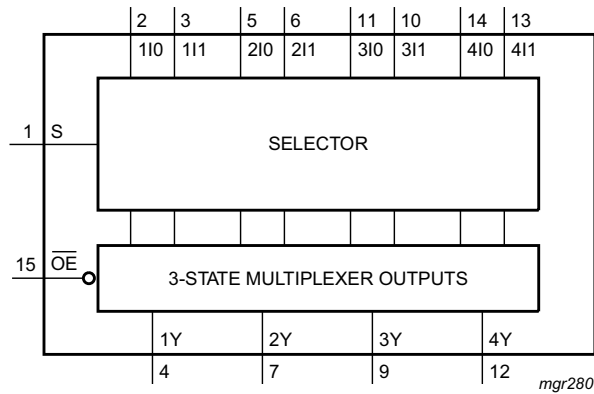


Fig 3. Functional diagram

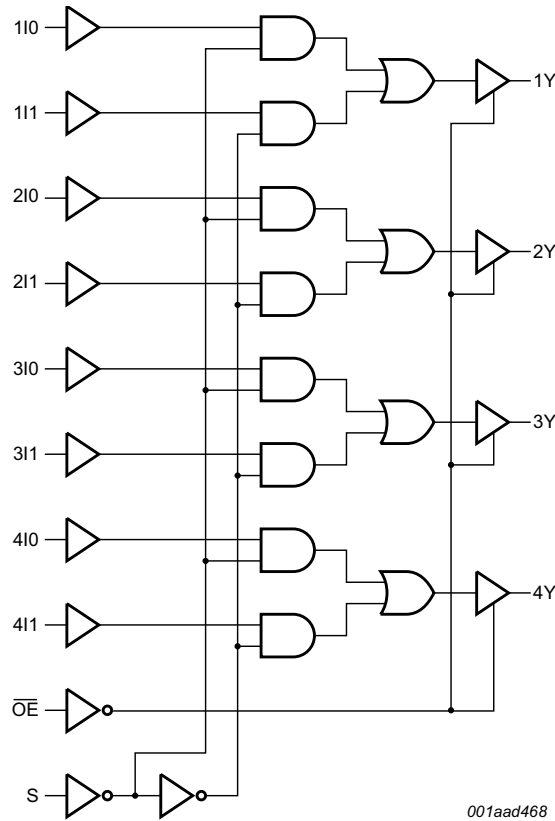


Fig 4. Logic diagram

## 5. Pinning information

### 5.1 Pinning

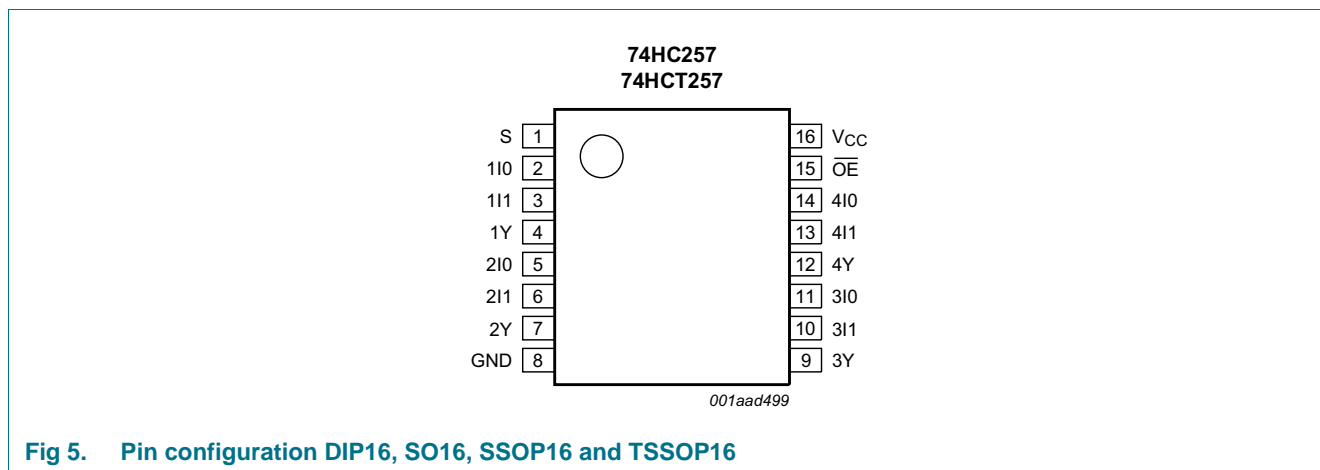


Fig 5. Pin configuration DIP16, SO16, SSOP16 and TSSOP16

### 5.2 Pin description

Table 2. Pin description

| Symbol          | Pin          | Description                              |
|-----------------|--------------|--|
| S               | 1            | common data select input                 |
| 1I0 to 4I0      | 2, 5, 11, 14 | data input from source 0                 |
| 1I1 to 4I1      | 3, 6, 10, 13 | data input from source 1                 |
| 1Y to 4Y        | 4, 7, 9, 12  | 3-state multiplexer output               |
| GND             | 8            | ground (0 V)                             |
| $\overline{OE}$ | 15           | 3-state output enable input (active LOW) |
| VCC             | 16           | supply voltage                           |

## 6. Functional description

### 6.1 Function table

Table 3. Function table<sup>[1]</sup>

| Control         |   | Input |     | Output |
|-----------------|---|-------|-----|--------|
| $\overline{OE}$ | S | nI0   | nI1 | nY     |
| H               | X | X     | X   | Z      |
| L               | H | X     | L   | L      |
| L               | H | X     | H   | H      |
| L               | L | L     | X   | L      |
| L               | L | H     | X   | H      |

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

## 7. Limiting values

**Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol    | Parameter                           | Conditions                                  | Min  | Max      | Unit |
|-----------|-------------------------------------|---|------|----------|------|
| $V_{CC}$  | supply voltage                      |   | -0.5 | +7       | V    |
| $I_{IK}$  | input clamping current              | $V_I < -0.5$ V or<br>$V_I > V_{CC} + 0.5$ V | -    | $\pm 20$ | mA   |
| $I_{OK}$  | output clamping current             | $V_O < -0.5$ V or<br>$V_O > V_{CC} + 0.5$ V | -    | $\pm 20$ | mA   |
| $I_O$     | output current                      | $V_O = -0.5$ V to $V_{CC} + 0.5$ V          | -    | $\pm 35$ | mA   |
| $I_{CC}$  | supply current                      |   | -    | +70      | mA   |
| $I_{GND}$ | ground current                      |   | -    | -70      | mA   |
| $T_{stg}$ | storage temperature                 |   | -65  | +150     | °C   |
| $P_{tot}$ | total power dissipation             |   |      |          |      |
|           |                                     | DIP16 package <a href="#">[1]</a>           | -    | 750      | mW   |
|           |                                     | SO16 package <a href="#">[2]</a>            | -    | 500      | mW   |
|           |                                     | SSOP16 package <a href="#">[3]</a>          | -    | 500      | mW   |
|           | TSSOP16 package <a href="#">[3]</a> | -   | 500  | mW       |      |

[1] For DIP16 packages: above 70 °C,  $P_{tot}$  derates linearly with 12 mW/K.

[2] For SO16 packages: above 70 °C,  $P_{tot}$  derates linearly with 8 mW/K.

[3] For SSOP16 and TSSOP16 packages: above 60 °C,  $P_{tot}$  derates linearly with 5.5 mW/K.

## 8. Recommended operating conditions

**Table 5. Recommended operating conditions**

| Symbol              | Parameter                            | Conditions       | Min | Typ  | Max      | Unit |
|---------------------|--------------------------------------|------------------|-----|------|----------|------|
| <b>74HC257</b>      |                                      |                  |     |      |          |      |
| $V_{CC}$            | supply voltage                       |                  | 2.0 | 5.0  | 6.0      | V    |
| $V_I$               | input voltage                        |                  | 0   | -    | $V_{CC}$ | V    |
| $V_O$               | output voltage                       |                  | 0   | -    | $V_{CC}$ | V    |
| $\Delta t/\Delta V$ | input transition rise and fall rates | $V_{CC} = 2.0$ V | -   | -    | 625      | ns   |
|                     |                                      | $V_{CC} = 4.5$ V | -   | 1.67 | 139      | ns   |
|                     |                                      | $V_{CC} = 6.0$ V | -   | -    | 83       | ns   |
| $T_{amb}$           | ambient temperature                  |                  | -40 | -    | +125     | °C   |
| <b>74HCT257</b>     |                                      |                  |     |      |          |      |
| $V_{CC}$            | supply voltage                       |                  | 4.5 | 5.0  | 5.5      | V    |
| $V_I$               | input voltage                        |                  | 0   | -    | $V_{CC}$ | V    |
| $V_O$               | output voltage                       |                  | 0   | -    | $V_{CC}$ | V    |
| $\Delta t/\Delta V$ | input transition rise and fall rates | $V_{CC} = 4.5$ V | -   | 1.67 | 139      | ns   |
| $T_{amb}$           | ambient temperature                  |                  | -40 | -    | +125     | °C   |

## 9. Static characteristics

**Table 6. Static characteristics**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol          | Parameter                 | Conditions   | 25 °C |      |      | -40 °C to +85 °C |      | -40 °C to +125 °C |       | Unit |
|-----------------|---------------------------|--|-------|------|------|------------------|------|-------------------|-------|------|
|                 |                           |  | Min   | Typ  | Max  | Min              | Max  | Min               | Max   |      |
| <b>74HC257</b>  |                           |  |       |      |      |                  |      |                   |       |      |
| V <sub>IH</sub> | HIGH-level input voltage  | V <sub>CC</sub> = 2.0 V  | 1.5   | 1.2  | -    | 1.5              | -    | 1.5               | -     | V    |
|                 |                           | V <sub>CC</sub> = 4.5 V  | 3.15  | 2.4  | -    | 3.15             | -    | 3.15              | -     | V    |
|                 |                           | V <sub>CC</sub> = 6.0 V  | 4.2   | 3.2  | -    | 4.2              | -    | 4.2               | -     | V    |
| V <sub>IL</sub> | LOW-level input voltage   | V <sub>CC</sub> = 2.0 V  | -     | 0.8  | 0.5  | -                | 0.5  | -                 | 0.5   | V    |
|                 |                           | V <sub>CC</sub> = 4.5 V  | -     | 2.1  | 1.35 | -                | 1.35 | -                 | 1.35  | V    |
|                 |                           | V <sub>CC</sub> = 6.0 V  | -     | 2.8  | 1.8  | -                | 1.8  | -                 | 1.8   | V    |
| V <sub>OH</sub> | HIGH-level output voltage | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>  |       |      |      |                  |      |                   |       |      |
|                 |                           | I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 2.0 V   | 1.9   | 2.0  | -    | 1.9              | -    | 1.9               | -     | V    |
|                 |                           | I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 4.5 V   | 4.4   | 4.5  | -    | 4.4              | -    | 4.4               | -     | V    |
|                 |                           | I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 6.0 V   | 5.9   | 6.0  | -    | 5.9              | -    | 5.9               | -     | V    |
|                 |                           | I <sub>O</sub> = -6.0 mA; V <sub>CC</sub> = 4.5 V  | 3.98  | 4.32 | -    | 3.84             | -    | 3.7               | -     | V    |
| V <sub>OL</sub> | LOW-level output voltage  | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>  |       |      |      |                  |      |                   |       |      |
|                 |                           | I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 2.0 V  | -     | 0    | 0.1  | -                | 0.1  | -                 | 0.1   | V    |
|                 |                           | I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 4.5 V  | -     | 0    | 0.1  | -                | 0.1  | -                 | 0.1   | V    |
|                 |                           | I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 6.0 V  | -     | 0    | 0.1  | -                | 0.1  | -                 | 0.1   | V    |
|                 |                           | I <sub>O</sub> = 6.0 mA; V <sub>CC</sub> = 4.5 V   | -     | 0.15 | 0.26 | -                | 0.33 | -                 | 0.4   | V    |
| I <sub>I</sub>  | input leakage current     | V <sub>I</sub> = V <sub>CC</sub> or GND; V <sub>CC</sub> = 6.0 V   | -     | -    | ±0.1 | -                | ±1.0 | ±1.0              | ±1.0  | μA   |
|                 |                           | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; V <sub>O</sub> = V <sub>CC</sub> or GND; V <sub>CC</sub> = 6.0 V | -     | -    | ±0.5 | -                | ±5.0 | ±10.0             | ±10.0 | μA   |
| I <sub>CC</sub> | supply current            | V <sub>I</sub> = V <sub>CC</sub> or GND; I <sub>O</sub> = 0 A; V <sub>CC</sub> = 6.0 V                                 | -     | -    | 8.0  | -                | 80   | 160               | 160   | μA   |
| C <sub>i</sub>  | input capacitance         |  | -     | 3.5  | -    |                  |      |                   |       | pF   |
| <b>74HCT257</b> |                           |  |       |      |      |                  |      |                   |       |      |
| V <sub>IH</sub> | HIGH-level input voltage  | V <sub>CC</sub> = 4.5 V to 5.5 V   | 2.0   | 1.6  | -    | 2.0              | -    | 2.0               | -     | V    |
| V <sub>IL</sub> | LOW-level input voltage   | V <sub>CC</sub> = 4.5 V to 5.5 V   | -     | 1.2  | 0.8  | -                | 0.8  | -                 | 0.8   | V    |
| V <sub>OH</sub> | HIGH-level output voltage | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; V <sub>CC</sub> = 4.5 V  |       |      |      |                  |      |                   |       |      |
|                 |                           | I <sub>O</sub> = -20 μA  | 4.4   | 4.5  | -    | 4.4              | -    | 4.4               | -     | V    |
| V <sub>OL</sub> | LOW-level output voltage  | I <sub>O</sub> = -6 mA   | 3.98  | 4.32 | -    | 3.84             | -    | 3.7               | -     | V    |
|                 |                           | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; V <sub>CC</sub> = 4.5 V  |       |      |      | -                | 0.1  | -                 | 0.1   |      |
|                 |                           | I <sub>O</sub> = 20 μA   | -     | 0    | 0.1  | -                | 0.33 | -                 | 0.4   | V    |
| I <sub>I</sub>  | input leakage current     | I <sub>O</sub> = 6.0 mA  | -     | 0.15 | 0.26 | -                | ±1.0 | -                 | ±1.0  | V    |
|                 |                           | V <sub>I</sub> = V <sub>CC</sub> or GND; V <sub>CC</sub> = 5.5 V   | -     | -    | ±0.1 | -                | ±5.0 | -                 | ±10   | μA   |

**Table 6. Static characteristics ...continued**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol           | Parameter                 | Conditions   | 25 °C |     |      | -40 °C to +85 °C |     | -40 °C to +125 °C |     | Unit |
|------------------|---------------------------|--|-------|-----|------|------------------|-----|-------------------|-----|------|
|                  |                           |  | Min   | Typ | Max  | Min              | Max | Min               | Max |      |
| I <sub>oz</sub>  | OFF-state output current  | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; V <sub>CC</sub> = 5.5 V; V <sub>O</sub> = V <sub>CC</sub> or GND per input pin; other inputs at V <sub>CC</sub> or GND; I <sub>O</sub> = 0 A | -     | -   | ±0.5 | -                | 80  | -                 | 160 | μA   |
| I <sub>CC</sub>  | supply current            | V <sub>I</sub> = V <sub>CC</sub> or GND; I <sub>O</sub> = 0 A; V <sub>CC</sub> = 5.5 V   | -     | -   | 8.0  |                  |     |                   |     | μA   |
| ΔI <sub>CC</sub> | additional supply current | V <sub>I</sub> = V <sub>CC</sub> - 2.1 V; other inputs at V <sub>CC</sub> or GND; V <sub>CC</sub> = 4.5 V to 5.5 V; I <sub>O</sub> = 0 A   |       |     |      |                  |     |                   |     |      |
|                  |                           | per input pin; nI0, nI1 inputs   | -     | 40  | 144  | -                | 180 | -                 | 196 | μA   |
|                  |                           | per input pin; $\overline{\text{OE}}$ input  | -     | 135 | 486  | -                | 608 | -                 | 662 | μA   |
|                  |                           | per input pin; S input   | -     | 70  | 252  | -                | 315 | -                 | 343 | μA   |
| C <sub>I</sub>   | input capacitance         |  | -     | 3.5 | -    |                  |     |                   |     | pF   |

## 10. Dynamic characteristics

**Table 7. Dynamic characteristics**

Voltages are referenced to GND (ground = 0 V); For test circuit see [Figure 8](#).

| Symbol           | Parameter         | Conditions  | 25 °C |     | -40 °C to +85 °C | -40 °C to +125 °C | Unit |
|------------------|-------------------|---|-------|-----|------------------|-------------------|------|
|                  |                   |   | Typ   | Max | Max              | Max               |      |
| <b>74HC257</b>   |                   |   |       |     |                  |                   |      |
| t <sub>pd</sub>  | propagation delay | nI0 to nY or nI1 to nY; see <a href="#">Figure 6</a> <span style="float:right">[1]</span>       |       |     |                  |                   |      |
|                  |                   | V <sub>CC</sub> = 2.0 V   | 36    | 110 | 140              | 165               | ns   |
|                  |                   | V <sub>CC</sub> = 4.5 V   | 13    | 22  | 28               | 33                | ns   |
|                  |                   | V <sub>CC</sub> = 5.0 V; C <sub>L</sub> = 15 pF   | 11    | -   | -                | -                 | ns   |
|                  |                   | V <sub>CC</sub> = 6.0 V   | 10    | 19  | 24               | 28                | ns   |
|                  |                   | S to nY; see <a href="#">Figure 6</a>   |       |     |                  |                   |      |
|                  |                   | V <sub>CC</sub> = 2.0 V   | 47    | 150 | 190              | 225               | ns   |
|                  |                   | V <sub>CC</sub> = 4.5 V   | 17    | 30  | 38               | 45                | ns   |
| t <sub>en</sub>  | enable time       | $\overline{\text{OE}}$ to nY; see <a href="#">Figure 7</a> <span style="float:right">[2]</span> |       |     |                  |                   |      |
|                  |                   | V <sub>CC</sub> = 2.0 V   | 33    | 150 | 190              | 225               | ns   |
|                  |                   | V <sub>CC</sub> = 4.5 V   | 12    | 30  | 38               | 45                | ns   |
|                  |                   | V <sub>CC</sub> = 6.0 V   | 10    | 26  | 33               | 38                | ns   |
| t <sub>dis</sub> | disable time      | $\overline{\text{OE}}$ to nY; see <a href="#">Figure 7</a> <span style="float:right">[3]</span> |       |     |                  |                   |      |
|                  |                   | V <sub>CC</sub> = 2.0 V   | 41    | 150 | 190              | 225               | ns   |
|                  |                   | V <sub>CC</sub> = 4.5 V   | 15    | 30  | 38               | 45                | ns   |
|                  |                   | V <sub>CC</sub> = 6.0 V   | 12    | 26  | 33               | 38                | ns   |

**Table 7. Dynamic characteristics ...continued**

Voltages are referenced to GND (ground = 0 V); For test circuit see [Figure 8](#).

| Symbol           | Parameter                     | Conditions  | 25 °C |     | -40 °C to +85 °C | -40 °C to +125 °C | Unit |
|------------------|-------------------------------|---|-------|-----|------------------|-------------------|------|
|                  |                               |   | Typ   | Max | Max              | Max               |      |
| t <sub>t</sub>   | transition time               | see <a href="#">Figure 6</a> <span style="float:right">[4]</span>   |       |     |                  |                   |      |
|                  |                               | V <sub>CC</sub> = 2.0 V   | 14    | 60  | 75               | 90                | ns   |
|                  |                               | V <sub>CC</sub> = 4.5 V   | 5     | 12  | 15               | 18                | ns   |
|                  |                               | V <sub>CC</sub> = 6.0 V   | 4     | 10  | 13               | 15                | ns   |
| C <sub>PD</sub>  | power dissipation capacitance | per multiplexer; V <sub>I</sub> = GND to V <sub>CC</sub> <span style="float:right">[5]</span>                     | 45    | -   |                  |                   | pF   |
| <b>74HCT257</b>  |                               |   |       |     |                  |                   |      |
| t <sub>pd</sub>  | propagation delay             | nI0 to nY or nI1 to nY; see <a href="#">Figure 6</a> <span style="float:right">[1]</span>                         |       |     |                  |                   |      |
|                  |                               | V <sub>CC</sub> = 4.5 V   | 16    | 30  | 38               | 45                | ns   |
|                  |                               | V <sub>CC</sub> = 5.0 V; C <sub>L</sub> = 15 pF   | 13    | -   | -                |                   | ns   |
|                  |                               | S to nY; see <a href="#">Figure 6</a>   |       |     |                  |                   |      |
|                  |                               | V <sub>CC</sub> = 4.5 V   | 20    | 35  | 44               | 53                | ns   |
|                  |                               | V <sub>CC</sub> = 5.0 V; C <sub>L</sub> = 15 pF   | 17    | -   |                  |                   | ns   |
| t <sub>en</sub>  | enable time                   | $\overline{OE}$ to nY; V <sub>CC</sub> = 4.5 V; see <a href="#">Figure 7</a> <span style="float:right">[2]</span> | 15    | 30  | 38               | 45                | ns   |
| t <sub>dis</sub> | disable time                  | $\overline{OE}$ to nY; V <sub>CC</sub> = 4.5 V; see <a href="#">Figure 7</a> <span style="float:right">[3]</span> | 16    | 30  | 38               | 45                | ns   |
| t <sub>t</sub>   | transition time               | V <sub>CC</sub> = 4.5 V; see <a href="#">Figure 6</a> <span style="float:right">[4]</span>                        | 5     | 12  | 15               | 18                | ns   |
| C <sub>PD</sub>  | power dissipation capacitance | per multiplexer; V <sub>I</sub> = GND to V <sub>CC</sub> - 1.5 V <span style="float:right">[5]</span>             | 45    | -   |                  |                   | pF   |

[1] t<sub>pd</sub> is the same as t<sub>PHL</sub>, t<sub>PLH</sub>.

[2] t<sub>en</sub> is the same as t<sub>PZH</sub>, t<sub>PZL</sub>.

[3] t<sub>dis</sub> is the same as t<sub>PHZ</sub>, t<sub>PLZ</sub>.

[4] t<sub>t</sub> is the same as t<sub>THL</sub>, t<sub>TLH</sub>.

[5] C<sub>PD</sub> is used to determine the dynamic power dissipation (P<sub>D</sub> in μW).

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum(C_L \times V_{CC}^2 \times f_o) \text{ where:}$$

f<sub>i</sub> = input frequency in MHz;

f<sub>o</sub> = output frequency in MHz;

C<sub>L</sub> = output load capacitance in pF;

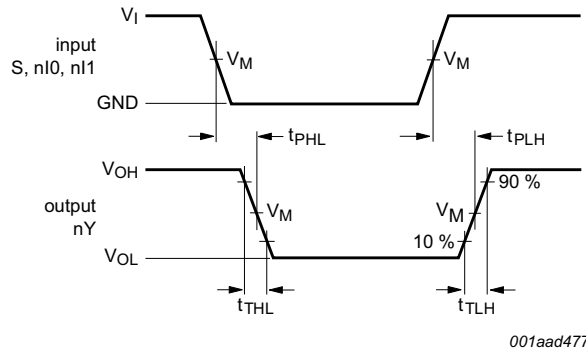
V<sub>CC</sub> = supply voltage in V;

N = number of inputs switching;

$\sum(C_L \times V_{CC}^2 \times f_o)$  = sum of outputs.



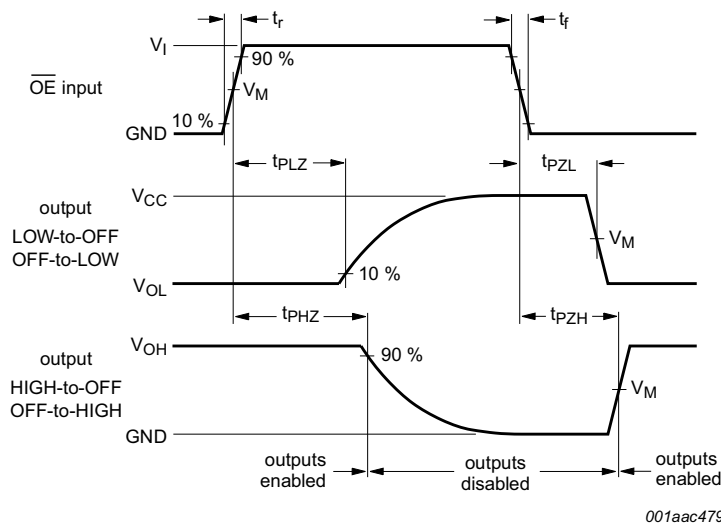
11. Waveforms



Measurement points are given in [Table 8](#).

$V_{OL}$  and  $V_{OH}$  are typical voltage output levels that occur with the output load.

**Fig 6. Propagation delays input (S, nI0, nI1) to output (nY) and output (nY) transition times**



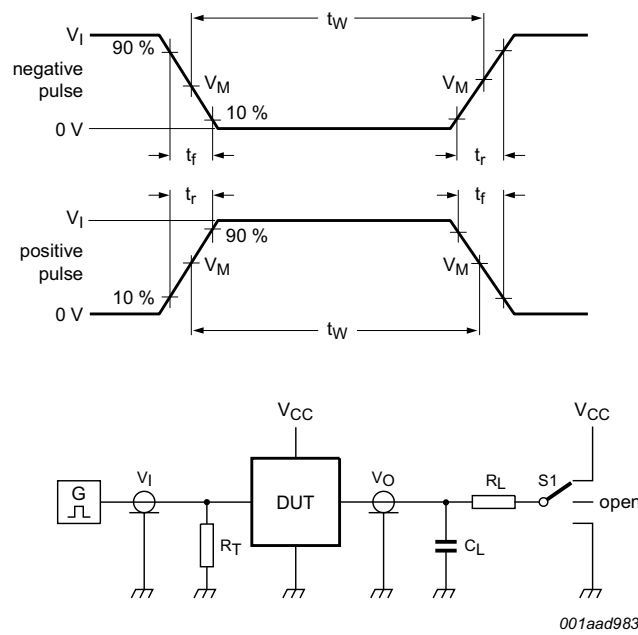
Measurement points are given in [Table 8](#).

$V_{OL}$  and  $V_{OH}$  are typical voltage output levels that occur with the output load.

**Fig 7. 3-state output enable and disable times**

**Table 8. Measurement points**

| Type     | Input       | Output      |
|----------|-------------|-------------|
|          | $V_M$       | $V_M$       |
| 74HC257  | $0.5V_{CC}$ | $0.5V_{CC}$ |
| 74HCT257 | 1.3 V       | 1.3 V       |



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Measurement points are given in [Table 8](#) and test data is given in [Table 9](#).

Definitions test circuit:

$R_T$  = Termination resistance should be equal to output impedance  $Z_o$  of the pulse generator.

$C_L$  = Load capacitance including jig and probe capacitance.

$R_L$  = Load resistor.

**Fig 8. Test circuit for measuring switching times**

**Table 9. Test data**

| Type     | Input    |            | Load  |              | Switch position    |                    |                    |
|----------|----------|------------|-------|--------------|--------------------|--------------------|--------------------|
|          | $V_I$    | $t_r, t_f$ | $C_L$ | $R_L$        | $t_{PHL}, t_{PLH}$ | $t_{PZH}, t_{PHZ}$ | $t_{PZL}, t_{PLZ}$ |
| 74HC257  | $V_{CC}$ | 6 ns       | 50 pF | 1 k $\Omega$ | open               | GND                | $V_{CC}$           |
| 74HCT257 | 3 V      | 6 ns       | 50 pF | 1 k $\Omega$ | open               | GND                | $V_{CC}$           |

12. Package outline

DIP16: plastic dual in-line package; 16 leads (300 mil)

SOT38-4

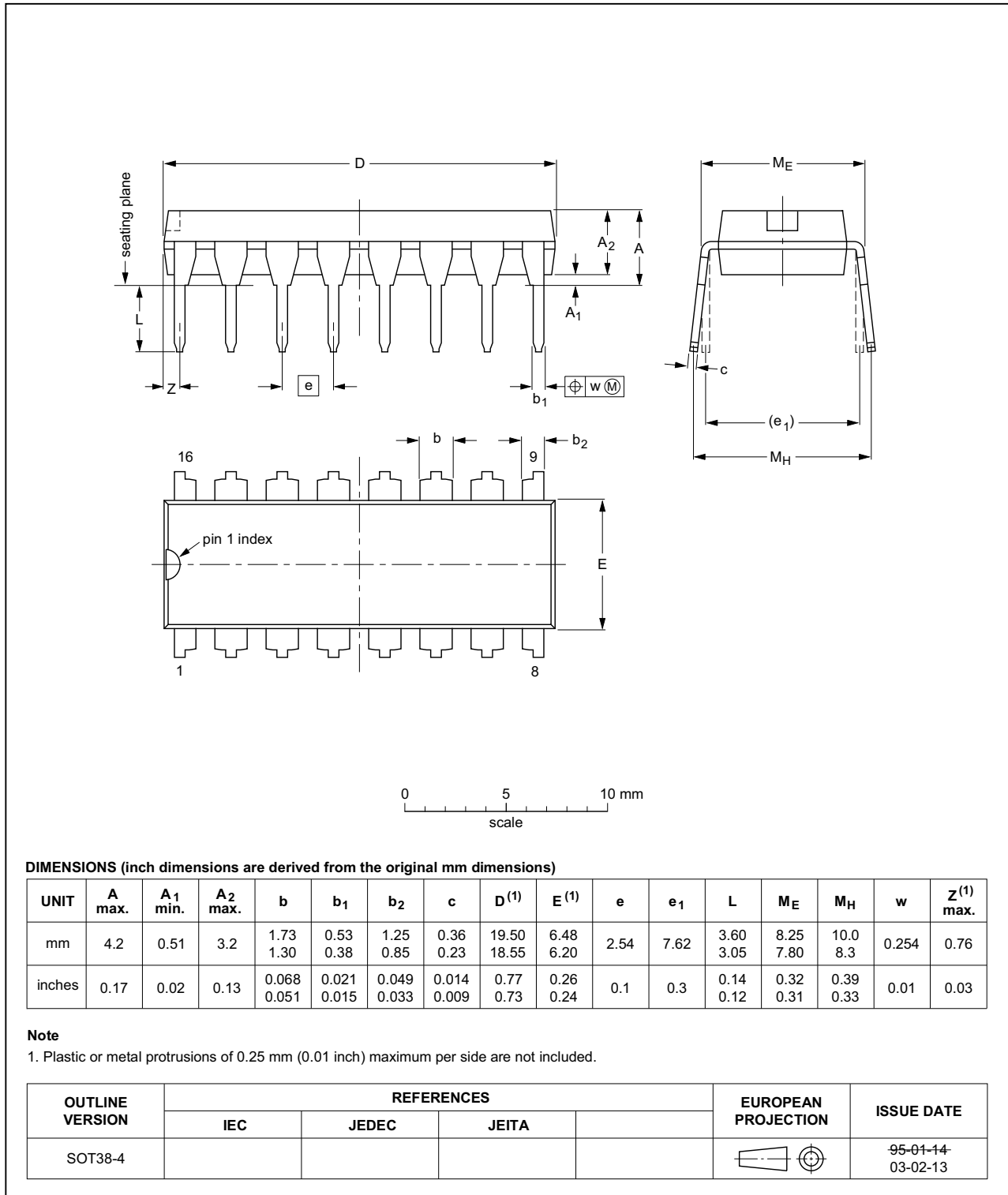


Fig 9. Package outline SOT38-4 (DIP16)

SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1

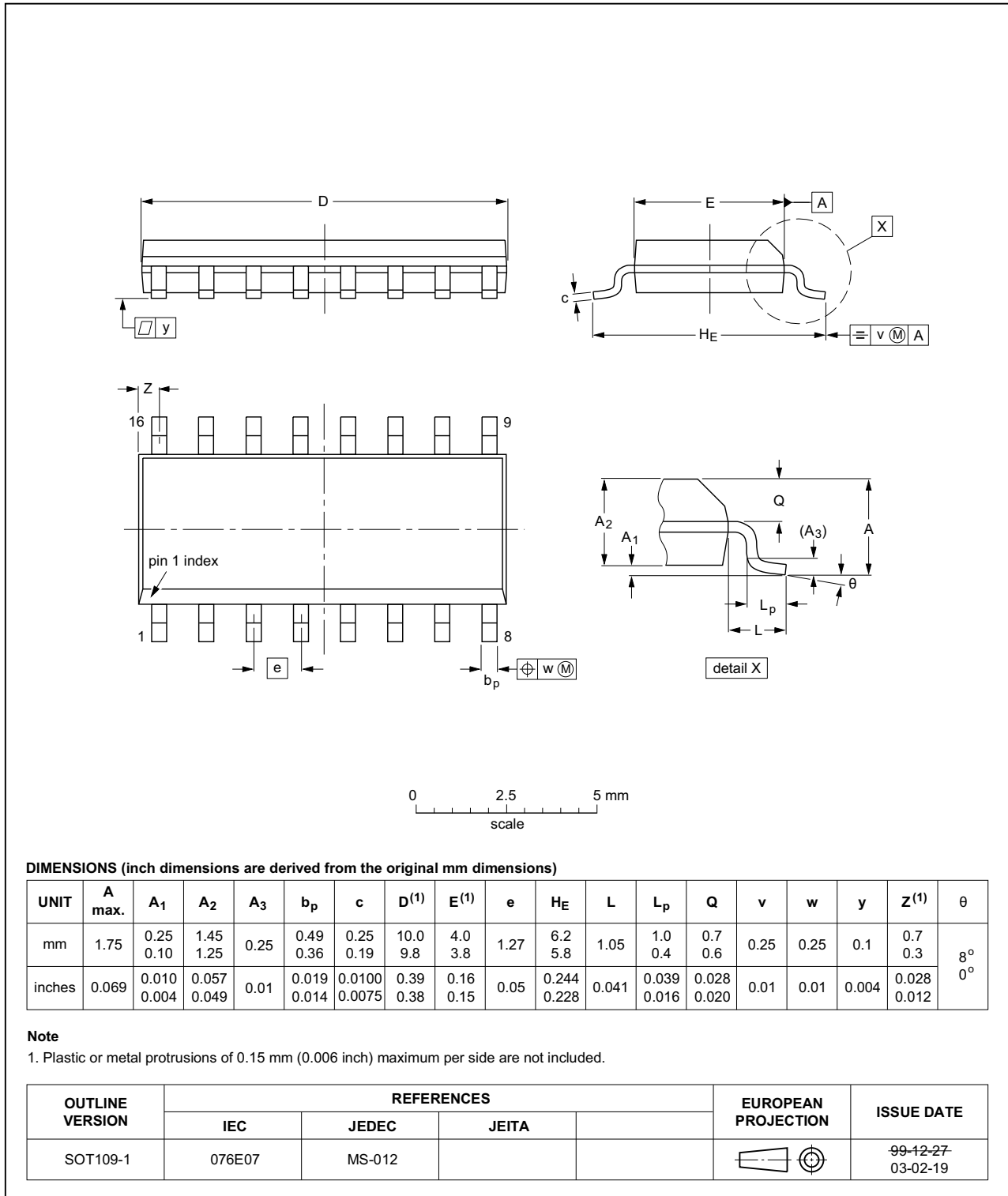


Fig 10. Package outline SOT109-1 (SO16)

SSOP16: plastic shrink small outline package; 16 leads; body width 5.3 mm

SOT338-1

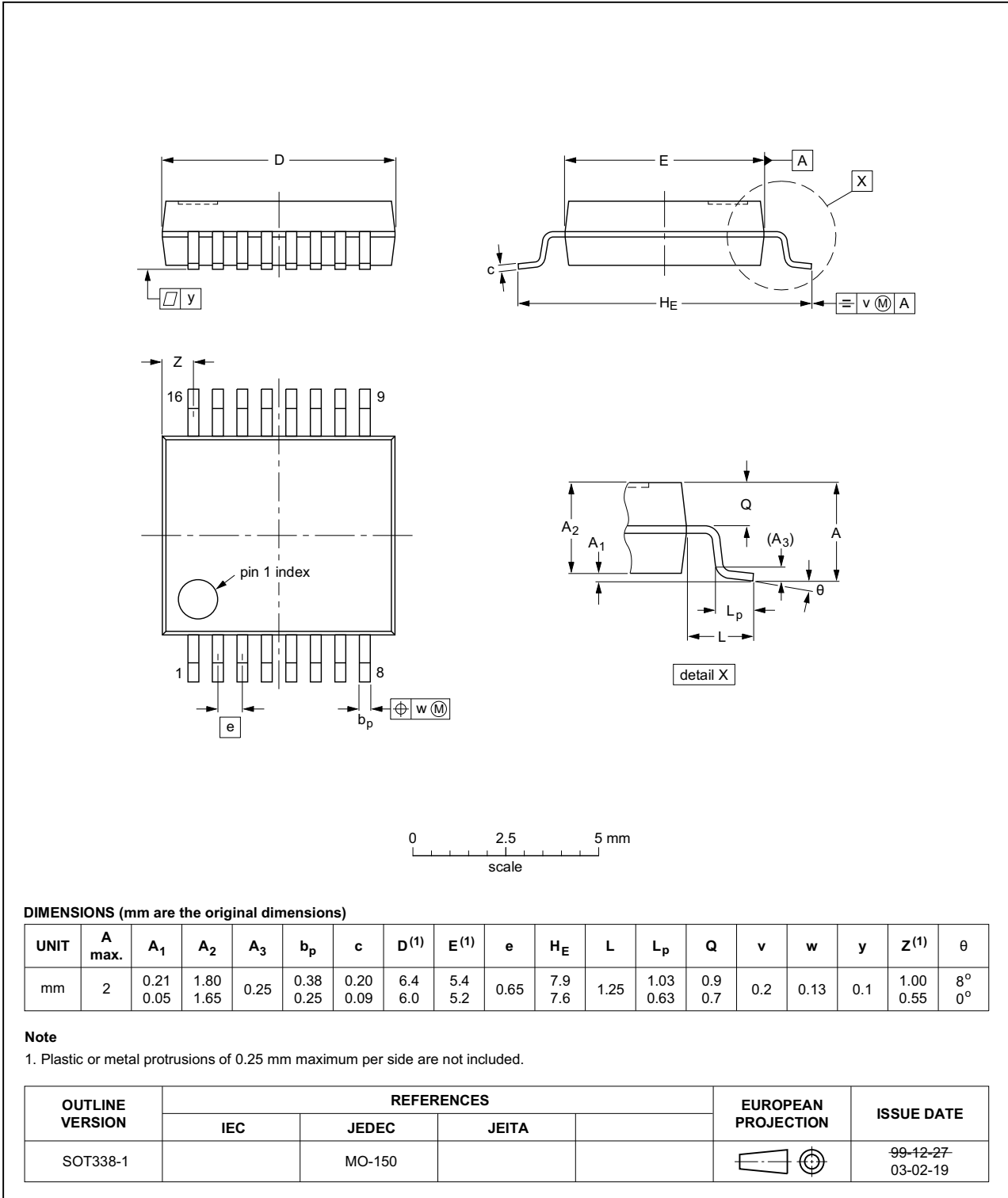


Fig 11. Package outline SOT338-1 (SSOP16)

TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1



Fig 12. Package outline SOT403-1 (TSSOP16)

## 13. Abbreviations

Table 10. Abbreviations

| Acronym | Description                             |
|---------|---|
| CMOS    | Complementary Metal Oxide Semiconductor |
| DUT     | Device Under Test                       |
| ESD     | ElectroStatic Discharge                 |
| HBM     | Human Body Model                        |
| MM      | Machine Model                           |
| TTL     | Transistor-Transistor Logic             |

## 14. Revision history

Table 11. Revision history

| Document ID         | Release date  | Data sheet status     | Change notice | Supersedes          |
|---------------------|---|-----------------------|---------------|---------------------|
| 74HC_HCT257 v.6     | 20150126  | Product data sheet    | -             | 74HC_HCT257 v.5     |
| Modifications:      | <ul style="list-style-type: none"> <li><a href="#">Table 7</a>: Power dissipation capacitance condition for 74HCT257 is corrected.</li> </ul> |                       |               |                     |
| 74HC_HCT257 v.5     | 20100113  | Product data sheet    | -             | 74HC_HCT257 v.4     |
| Modifications:      | <ul style="list-style-type: none"> <li><a href="#">Table 7</a>: changed <math>\overline{3OE}</math> to <math>\overline{OE}</math></li> </ul>  |                       |               |                     |
| 74HC_HCT257 v.4     | 20090608  | Product data sheet    | -             | 74HC_HCT257 v.3     |
| 74HC_HCT257 v.3     | 20050920  | Product data sheet    | -             | 74HC_HCT257_CNV v.2 |
| 74HC_HCT257_CNV v.2 | 19980930  | Product specification | -             | -                   |

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| Document status <sup>[1][2]</sup> | Product status <sup>[3]</sup> | Definition  |
|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet      | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet    | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet        | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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